# SP2T RF Switch

HSWA2-63DR+

Absorptive RF Switch with internal driver Single Supply Voltage, +2.7V to +5.5V

# **The Big Deal**

- · High Isolation, 69 dB at 1.0 GHz
- High Input IP3, +65 dBm
- · Fast switching, 300 ns
- Tiny Size, 4x4mm



CASE STYLE: DG983-3

# **Product Overview**

Mini-Circuits' HSWA2-63DR+ is a MMIC SPDT absorptive switch with an internal driver designed for wideband operation from 100 MHz to 6.0 GHz supporting many applications requiring high performance across a wide frequency range. This model provides excellent isolation, fast switching speed and high linearity in a tiny 4x4mm 20-Lead MCLP package. Produced using a unique CMOS process on silicon, it offers the performance of GaAs with the advantages of conventional CMOS devices. HSWA2-63DR+ provides a high level of ESD protection and excellent repeatability.

# **Key Features**

Feature	Advantages
Wideband, 100 MHz to 6.0 GHz Usable over 1kHz to 6 GHz	One model can be used in many applications, saving component count. Also ideal for wideband applications such as military and instrumentation.  With lower input power it can operate over 1kHz to 6 GHz covering even wider applications
Absorptive switch	In the off condition, RF output ports which are not switched ON are terminated into $50\Omega$ . This enables proper impedance termination of the circuitry following the RF output ports, preventing any unintended action such as oscillation.
High Isolation: • 71 dB at 1000 MHz • 48 dB at 6000 MH	High isolation significantly reduces leakage of power into OFF ports.
High linearity, +65 dBm IIP3	High linearity minimizes unwanted intermodulation products which are difficult or impossible to filter in multi-carrier environments such as CATV, or in the presence of strong interfering signal from adjacent circuitry or received by antenna.
Tiny size, 4 x 4mm MCLP package	Tiny footprint saves space in dense layouts while providing low inductance, repeatable transitions, and excellent thermal contact to the PCB.

Absorptive RF Switch with internal driver Single Supply Voltage, +2.7V to +5.5V

### **Product Features**

- High Isolation, 69 dB typ. at 1 GHz
- Low insertion loss, 0.95 dB typ. at 1 GHz
- High Input IP3, 65 dBm typ.
- Fast switching time, 300 ns typ.
- Low current consumption, 120 μA typ.
- Wide bandwidth, 100-6000 MHz, usable over 1kHz-6000 MHz





# HOWAL CODITI

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site

for RoHS Compliance methodologies and qualifications

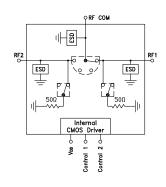
# **Typical Applications**

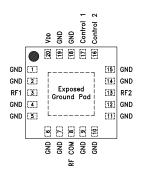
- Defense
- Test and Measurements
- Switch matrices

# **General Description**

HSWA2-63DR+ is a high isolation absorptive SPDT switch with integral CMOS driver, operates with single positive supply voltage while consuming, 120  $\mu$ A typical. It has been designed for very wide band operation. It is packaged in a 4mm x 4mm x0.9mm 20-lead MCLP package and is rated MSL3.

### Simplified Schematic and Pad Description





Function	Pad Number	Description
RF COM	8	RF common/ SUM port*
RF1	3	RF out #1/In port #1*
RF2	13	RF out #1/In port #2*
Control 1	17	CMOS Control IN #1
Control 2	16	CMOS Control IN #2
VDD	20	Supply voltage
GND	1.2,4-7,9,10-12 14,15,18,19	Ground

<sup>\*</sup> Must be held at 0VDC. If required add DC blocking capacitors on these ports.



# RF Electrical Specifications<sup>1</sup>, 100 MHz - 6 GHz, $T_{AMB}$ =25°C, $V_{DD}$ = +3.0V, 50 Ohms

Parameter	Condition (MHz)	Min.	Тур.	Max.	Units
Frequency range		100		6000	MHz
Insertion loss <sup>2,4</sup>	100 - 1000	_	0.95	1.15	
	1000 - 2000	_	0.95	1.15	
	2000 - 3000	_	1.0	1.2	dB
Insertion loss-,	3000 - 4000	_	1.15	1.35	l db
	4000 - 5000	_	1.25	1.55	
	5000 - 6000	_	1.60	1.90	
	100 - 1000	69	71	_	
	1000 - 2000	65	67	_	
location between Common next and DE1/DE2 Darts	2000 - 3000	63	68	_	dD.
Isolation between Common port and RF1/RF2 Ports	3000 - 4000	62	67	_	dB
	4000 - 5000	52	57	_	
	5000 - 6000	44	48		
	100 - 1000	67	69	_	
	1000 - 2000	63	64	_	
Isolation between RF1 and RF2 Ports	2000 - 3000	59	62	_	dB
Isolation between RFT and RF2 Ports	3000 - 4000	60	64	_	
	4000 - 5000	54	60	_	
	5000 - 6000	44	50		
	100 - 4000	_	20	_	
Return loss (All Ports)	4000 - 5000	_	15	_	dB
	5000 - 6000	_	13		
Input IP2	100 - 6000		110		dBm
Input IP3	100 - 6000	60	65	_	dBm
1.0 dB Input compression <sup>3</sup>	100 - 6000	33	35	_	dBm
Thermal Resistance, junction-to-ambient			78		°C/W

# **DC Electrical Specifications**

Parameter	Min.	Тур.	Max.	Units
Supply voltage, V <sub>DD</sub>	2.7		5.5	V
Supply current		120	200	μA
Control voltage Low	-0.3		0.6	V
Control voltage High	1.17		3.6	V
Control current		9	12	μA

- Notes:

  1. Tested on Mini-Circuits' test board TB-919+, using Agilent's N5230A network analyzer (see Characterization test circuit, Fig.2).

  2. Insertion loss values are de-embedded from test board loss.
- 3. Do not exceed RF input power as shown in Absolute Maximum Ratings table.
- 4. Insertion loss and return loss can be improved by external matching.

### **Switching Specifications**

Parameter	Condition	Min.	Тур.	Max.	Units
Switching time 50% control to 90/10%RF	fctrl=1KHz V <sub>DD</sub> =3V Vctrl High=1.8V Vctrl Low=0V	_	300	400	nS
Video feed-through		_	27	_	mV <sub>P-P</sub>
Rise/Fall time 10 to 90% or 90 to 10%		_	67	_	ns

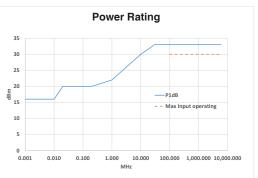


Figure 1. P1dB and Max Input Operating Power vs. Frequency

# Absolute Maximum Ratings<sup>5</sup>

Parameter	Ratings	
Operating temperature -40°C to +105°		
Storage temperature	-65°C to 150°C	
V <sub>DD</sub> , Supply voltage	-0.3 to 5.5V	
Voltage control	-0.3V Min. 3.6 Max.	
RF Input power, CW <sup>6</sup>	+30 dBm	
RF Power into output ports <sup>6</sup>	+20 dBm	
Maximum Die Junction Temperature	150°C	

<sup>5.</sup> Operation of this device above any of these conditions may cause permanent damage. 6. 100% Duty Cycle, all band,  $50\Omega$ 

# **Truth Table**

	State of Control voltage		
Mode	Control 1 Control 2		
RF COM-RF1 ON	HIGH	LOW	
RF COM-RF2 ON	LOW	HIGH	
ALL OFF	LOW	LOW	
Unsupported	HIGH	HIGH	

# **Characterization / Application Test Circuit**

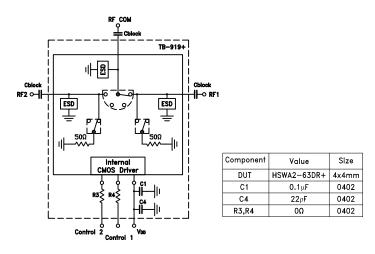


Figure 2. Block Diagram of test Circuit used for characterization (DUT soldered on Mini-Circuits' TB-919+) Note: Cblock is required only when DC is present on RF ports.

# **Product Marking**

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### **Additional Detailed Technical Information**

additional information is available on our dash board. To access this information click here

Performance Data	Data Table		
Performance Data	Swept Graphs		
Case Style	DG983-3 Plastic package, exposed paddle Termination finish: NiPdAu		
Tape & Reel	F87		
Standard quantities available on reel	7" reels with 20, 50, 100, 200, 500, 1000 & 3000 devices		
Suggested Layout for PCB Design	PL-510		
Evaluation Board	TB-919+		
Environmental Ratings	ENV83		

# **ESD Rating**

Human Body Model (HBM): Class 2 (Pass 2000V) in accordance with MIL-STD-883, Method 3015

# **MSL Rating**

Moisture Sensitivity: MSL3 in accordance with IPC/JEDEC J-STD-020D

### **Additional Notes**

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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